



74LVC1G00 SINGLE 2 INPUT POSITIVE NAND GATE

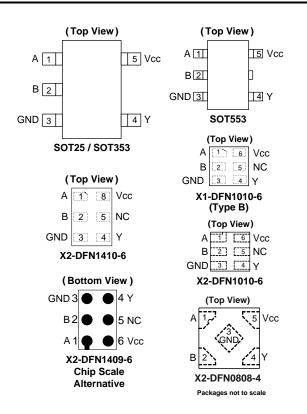
### Description

The 74LVC1G00 is a single 2-input positive NAND gate with a standard push-pull output. The device is designed for operation with a power supply range of 1.65V to 5.5V. The inputs are tolerant to 5.5V allowing this device to be used in a mixed voltage environment. The device is fully specified for partial power down applications using  $I_{OFF}$ . The  $I_{OFF}$  circuitry disables the output preventing damaging current backflow when the device is powered down.

The gate performs the positive Boolean function:

$$Y = \overline{A \bullet B} \text{ or } Y = \overline{A} + \overline{B}$$

### Pin Assignments



### Features

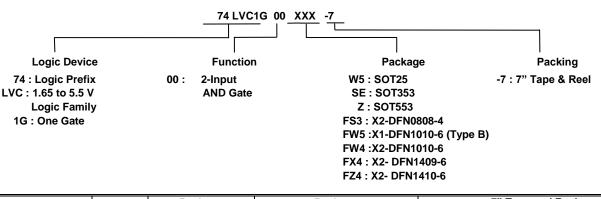
- Wide Supply Voltage Range from 1.65 to 5.5V
- ± 24mA Output Drive at 3.3V
- CMOS low power consumption
- IOFF Supports Partial-Power-Down Mode Operation
- Inputs accept up to 5.5V
- ESD Protection Tested per JESD 22
  - Exceeds 200-V Machine Model (A115)
  - Exceeds 2000-V Human Body Model (A114)
  - Exceeds 1000-V Charged Device Model (C101)
  - Latch-Up Exceeds 100mA per JESD 78, Class I
- Range of Package Options
- Direct Interface with TTL Levels
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

# Applications

- Voltage Level Shifting
- General Purpose Logic
- Power Down Signal Isolation
- Wide array of products such as:
  - PCs, Networking, Notebooks, Netbooks, PDAs
  - Tablet Computers, E-readers
  - Computer Peripherals, Hard Drives, CD/DVD ROM
  - TV, DVD, DVR, Set-Top Box
  - Cell Phones, Personal Navigation / GPS
  - MP3 Players, Cameras, Video Recorders
- Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
  - 2. See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
  - 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.



## Ordering Information (Note 4)



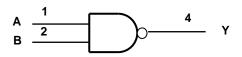
Part Number	Package	Package	Package	7" Tape a	nd Reel		
	Code	(Notes 5 & 6)	Size	Quantity	Part Number Suffix		
74LVC1G00W5-7	W5	SOT25	3.0mm x 2.8mm x 1.2mm 0.95 mm lead pitch	3,000/Tape & Reel	-7		
74LVC1G00SE-7	SE	SOT353	2.0mm x 2.0mm x 1.1mm 0.65 mm lead pitch	3,000/Tape & Reel	-7		
74LVC1G00Z-7	Z	SOT553	1.6mm x 1.6 mm x 0.62mm 0.5 mm lead pitch	4,000/Tape & Reel	-7		
74LVC1G00FS3-7	FS3	X2-DFN0808-4	0.8mm x 0.8mm x 0.35mm 0.5 mm pad pitch (diamond)	5,000/Tape & Reel	-7		
74LVC1G00FW5-7	FW5	X1-DFN1010-6 (Type B)	1.0mm x 1.0mm x 0.5mm 0.35 mm pad pitch	5,000/Tape & Reel	-7		
74LVC1G00FW4-7	FW4	X2-DFN1010-6	1.0mm x 1.0mm x 0.4mm 0.35 mm pad pitch	5,000/Tape & Reel	-7		
74LVC1G00FX4-7	FX4	X2-DFN1409-6 Chip scale alternative	1.4mm x 0.9mm x 0.4mm 0.5 mm pad pitch	5,000/Tape & Reel	-7		
74LVC1G00FZ4-7	FZ4	X2-DFN1410-6	1.4mm x 1.0mm x 0.4mm 0.5 mm pad pitch	5,000/Tape & Reel	-7		
Notes: 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.							

4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.
5. Pad layout as shown in Diodes Inc. suggested pad layouts, which can be found on our website at see http://www.diodes.com/package-outlines.html. 6. The taping orientation is located on our website at http://www.diodes.com/datasheets/ap02007.pdf.

### **Pin Descriptions**

Pin Name	Description	
А	Data Input	
В	Data Input	
GND	Ground	
Y	Data Output	
V <sub>CC</sub>	Supply Voltage	
NC No Connection		

## Logic Diagram



# **Function Table**

Inp	Output	
Α	В	Y
н	Н	L
L	Х	Н
х	L	Н



## Absolute Maximum Ratings (Notes 7 & 8)

Symbol	Description	Rating	Unit
ESD HBM	Human Body Model ESD Protection	2	kV
ESD CDM	Charged Device Model ESD Protection	1	kV
ESD MM	Machine Model ESD Protection	200	V
V <sub>CC</sub>	Supply Voltage Range	-0.5 to 6.5	V
VI	Input Voltage Range	-0.5 to 6.5	V
Vo	Voltage applied to output in high impedance or IOFF state	-0.5 to 6.5	V
Vo	Voltage applied to output in high or low state	-0.5 to V <sub>CC</sub> +0.5	V
I <sub>IK</sub>	Input Clamp Current VI<0	-50	mA
Іок	Output Clamp Current	-50	mA
lo	Continuous Output Current	±50	mA
I <sub>CC,</sub> I <sub>GND</sub>	Continuous current through V <sub>CC</sub> or GND	±100	mA
TJ	Operating Junction Temperature	-40 to +150	°C
T <sub>STG</sub>	Storage Temperature	-65 to +150	°C

Notes: 7. Stresses beyond the absolute maximum may result in immediate failure or reduced reliability. These are stress values and device operation should be within recommend values.

8. Forcing the maximum allowed voltage could cause a condition exceeding the maximum current or conversely forcing the maximum current could cause a condition exceeding the maximum voltage. The ratings of both current and voltage must be maintained within the controlled range.

Symbol		Parameter	Min	Max	Unit
Maa	Operating Voltage		1.65	5.5	V
Vcc	Operating voltage	Data retention only	1.5	—	V
	V <sub>CC</sub> = 1.65V to 1.95V	0.65 x V <sub>CC</sub>	—		
N/		$V_{CC} = 2.3V \text{ to } 2.7V$	1.7	—	V
VIH	High-Level Input Voltage	V <sub>CC</sub> = 3V to 3.6V	2	—	v
		$V_{CC} = 4.5V \text{ to } 5.5V$	0.7 x V <sub>CC</sub>	—	
		V <sub>CC</sub> = 1.65V to 1.95V	_	0.35 x V <sub>CC</sub>	
.,		V <sub>CC</sub> = 2.3V to 2.7V	_	0.7	.,
VIL	Low-Level Input Voltage	V <sub>CC</sub> = 3V to 3.6V	_	0.8	V
		V <sub>CC</sub> = 4.5V to 5.5V	_	0.3 x V <sub>CC</sub>	
VI		Input Voltage	0	5.5	V
Vo		Output Voltage	0	V <sub>CC</sub>	V
	V <sub>CC</sub> = 1.65V	—	-4		
		V <sub>CC</sub> = 2.3V	—	-8	
		V <sub>CC</sub> = 2.7V	_	-12	- 
I <sub>OH</sub>	High-Level Output Current		_	-16	mA
		$V_{CC} = 3V$		-24	
		$V_{CC} = 4.5V$	—	-32	
		V <sub>CC</sub> = 1.65V	_	4	
		V <sub>CC</sub> = 2.3V	_	8	
		V <sub>CC</sub> = 2.7V	_	12	
IOL	Low-Level Output Current		_	16	- mA
		$V_{CC} = 3V$	_	24	
		$V_{CC} = 4.5V$	—	32	
		V <sub>CC</sub> = 1.8V ± 0.15V, 2.5V ± 0.2V	—	20	
Δt/ΔV	Input Transition Rise or Fall Rate	$V_{CC} = 3.3 V \pm 0.3 V$	—	10	ns/V
Kate		$V_{CC} = 5V \pm 0.5V$	_	5	
T <sub>A</sub>	Operating Free-Air Temperature	-	-40	+125	°C

## Recommended Operating Conditions (Note 9)

Note: 9. Unused inputs should be held at  $V_{\mbox{CC}}$  or Ground.



### **Electrical Characteristics** (All typical values are at $V_{CC} = 3.3V$ , $T_A = +25^{\circ}C$ )

Symbol	Parameter	Test Conditions	V	-40	°C to +85	°C	-40°C to	+125°C	Unit
Symbol	Parameter	Test Conditions	Vcc	Min	Тур	Max	Min	Max	Unit
		I <sub>OH</sub> = -100μA	1.65V to 5.5V	V <sub>CC</sub> – 0.1	-	_	V <sub>CC</sub> -0.1	_	
		$I_{OH} = -4mA$	1.65V	1.2		_	0.95		
		$I_{OH} = -8mA$	2.3V	1.9		_	1.7		
Vон	High Level Output Voltage	I <sub>OH</sub> = -12mA	2.7V	2.2		_	1.9		V
	o apar voltage	I <sub>OH</sub> = -16mA	3V	2.4	-	_	2.2	_	
		I <sub>OH</sub> = -24mA	37	2.3	-	_	2.0	_	
		I <sub>OH</sub> = -32mA	4.5V	3.8		_	3.4		
		I <sub>OL</sub> = 100μA	1.65V to 5.5V	—		0.1	—	0.1	
		$I_{OL} = 4mA$	1.65V	—	_	0.45	—	0.7	
		I <sub>OL</sub> = 8mA	2.3V	—	-	0.3	—	0.45	v
V <sub>OL</sub>	Low Level Output Voltage	$I_{OL} = 12mA$	2.7V	_	-	0.4	_	0.6	
	Oulput Voltage	$I_{OL} = 16 \text{mA}$	3V	—	-	0.4	—	0.6	
		$I_{OL} = 24mA$	3V	_		0.55	_	0.8	
		I <sub>OL</sub> = 32mA	4.5V	—		0.55	—	.8	
lı –	Input Current	$V_1 = 5.5V$ or GND	0 to 5.5V	—	± 0.1	±5	—	± 100	μA
IOFF	Power Down Leakage Current	$V_{I} \text{ or } V_{O} = 5.5 V$	0V	_	_	±10	_	±200	μΑ
Icc	Supply Current	V <sub>1</sub> = 5.5V or GND I <sub>O</sub> =0	5.5V	_	0.1	10	_	200	μA
ΔI <sub>CC</sub>	Additional Supply Current	One input at $V_{CC}$ –0.6V Other inputs at $V_{CC}$ or GND	3V to 5.5V	_	_	500	_	5,000	μΑ
Ci	Input Capacitance	$V_i = V_{CC} - or GND$	3.3V	_	5	—	_	_	pF

# Package Characteristics

Symbol	Parameter	Test Conditions	Vcc	Min	Тур.	Мах	Unit
	SOT25		_	204	_		
		SOT353		_	371	_	
		SOT553		_	231	_	
0	Thermal Resistance	X2-DFN0808-4	(N=1-40)	_	400	_	0000
$\theta_{JA}$	Junction-to-Ambient	X1-DFN1010-6 (Type B)	(Note 10)	_	435	_	°C/W
		X2-DFN1010-6		_	445	_	
		X2-DFN1409-6		_	470	_	
		X2-DFN1410-6		_	460	_	
		SOT25		_	52	_	
		SOT353		_	143	_	
		SOT553		_	105	_	
0	Thermal Resistance	X2-DFN0808-4	$(N_{1}, t_{2}, t_{3})$	_	225	_	80 AA/
θJC	Junction-to-Case	X1-DFN1010-6 (Type B)	(Note 10)	_	250	_	°C/W
		X2-DFN1010-6			250	_	
		X2-DFN1409-6			275	_	
		X2-DFN1410-6		_	265	_	

Note: 10. Test condition for each of the 8 package types: Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.



Unit

ns

5.5

## **Switching Characteristics**

Figure 1 Typi	Figure 1 Typical Values at $T_A = +25^{\circ}$ C and nominal voltages 1.8V, 2.5V, 2.7V, 3.3V, and 5.0V.							
Parameter	From	То	Vcc	T,	₄ = -40°C to 85	°C	T <sub>A</sub> = -40°C	C to 125°C
Farameter	Input	Output	VCC	Min	Тур	Max	Min	Max
			1.8V ± 0.15V	1.0	3.3	8.0	1.0	10.5
			2.5V ± 0.2V	0.5	2.2	5.5	0.5	7.0
t <sub>pd</sub>	A or B	Y	2.7V	0.5	2.6	5.8	0.5	7.5
			3.3V ± 0.3V	0.5	2.2	4.7	0.5	6.0

0.5

1.8

4.0

0.5

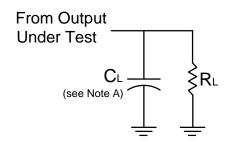
5.0V ± 0.5V

# **Operating Characteristics**

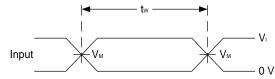
T <sub>A</sub> = +25°C							
	Denemerten	Test	V <sub>CC</sub> = 1.8V	V <sub>CC</sub> = 2.5V	$V_{CC} = 3.3V$	$V_{CC} = 5V$	Unit
	Parameter		Тур	Тур	Тур	Тур	Unit
C <sub>pd</sub>	Power Dissipation Capacitance	f = 10 MHz	22	22	23	25	pF



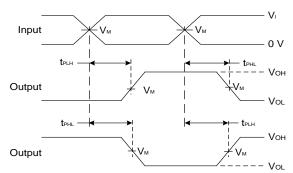
### **Parameter Measurement Information**



Vcc	Inputs		V <sub>M</sub>	C∟	RL	
VCC	VI	t <sub>r</sub> /t <sub>f</sub>	¥ M	5		
1.8V ± 0.15V	V <sub>CC</sub>	≤2ns	V <sub>CC</sub> /2	30pF	1ΚΩ	
2.5V ± 0.2V	Vcc	≤2ns	V <sub>CC</sub> /2	30pF	500Ω	
2.7V	V <sub>CC</sub>	≤2.5ns	1.5V	50pF	500Ω	
3.3V ± 0.3V	3.0V	≤2.5ns	1.5V	50pF	500Ω	
5.0V ± 0.5V	V <sub>CC</sub>	≤2.5ns	V <sub>CC</sub> /2	50pF	500Ω	



**Voltage Waveform Pulse Duration** 



**Voltage Waveform Propagation Delay Times** Inverting and Non Inverting Outputs

### Figure 1. Load Circuit and Voltage Waveforms

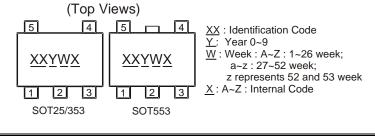
A. Includes test lead and test apparatus capacitance. Notes:

- B. All pulses are supplied at pulse repetition rate  $\leq$  10 MHz. C. Inputs are measured separately one transition per measurement.
  - D.  $t_{PLH}$  and  $t_{PHL}$  are the same as  $t_{PD}$ .



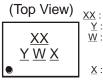
## **Marking Information**

### (1) SOT25, SOT353 and SOT553



Part Number	Package	Identification Code
74LVC1G00W5-7	SOT25	US
74LVC1G00SE-7	SOT353	US
74LVC1G00Z-7	SOT553	US

### (2) DFN packages

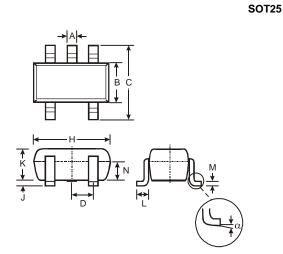


 $\begin{array}{l} \underline{XX}: \mbox{ Identification Code} \\ \underline{Y}: \mbox{ Year 0~9} \\ \underline{W}: \mbox{ Week : A~Z : 1~26 week;} \\ a~z: 27~52 week; \\ z \mbox{ represents 52 and 53 week} \\ \underline{X}: \mbox{ A~Z : Internal Code} \end{array}$ 

Part Number	Package	Identification Code
74LVC1G00FS3-7	X2-DFN0808-4	WS
74LVC1G00FW5-7	X1-DFN1010-6 (Type B)	V2
74LVC1G00FW4-7	X2-DFN1010-6	US
74LVC1G00FX4-7	X2-DFN1409-6	MA
74LVC1G00FZ4-7	X2-DFN1410-6	US



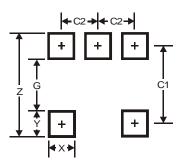
Please see http://www.diodes.com/package-outlines.html for the latest version.



	SOT25			
Dim	Min	Max	Тур	
Α	0.35	0.50	0.38	
В	1.50	1.70	1.60	
С	2.70	3.00	2.80	
D	-	-	0.95	
н	2.90	3.10	3.00	
J	0.013	0.10	0.05	
ĸ	1.00	1.30	1.10	
L	0.35	0.55	0.40	
М	0.10	0.20	0.15	
Ν	0.70	0.80	0.75	
α	0°	8°	1	
All Dimensions in mm				

## **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.

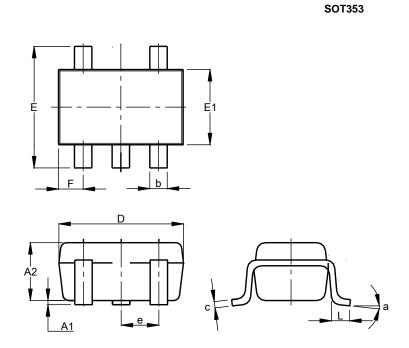


Dimensions	Value
Z	3.20
G	1.60
Х	0.55
Y	0.80
C1	2.40
C2	0.95

SOT25



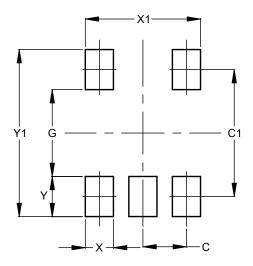
Please see http://www.diodes.com/package-outlines.html for the latest version.



SOT353				
Dim	Min	Max	Тур	
A1	0.00	0.10	0.05	
A2	0.90	1.00	1.00	
b	0.10	0.30	0.25	
С	0.10	0.22	0.11	
D	1.80	2.20	2.15	
Е	2.00	2.20	2.10	
E1	1.15	1.35	1.30	
е	C	).650 B	SC	
F	0.40	0.45	0.425	
L	0.25	0.40	0.30	
а	0°	8°		
All Dimensions in mm				

## Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

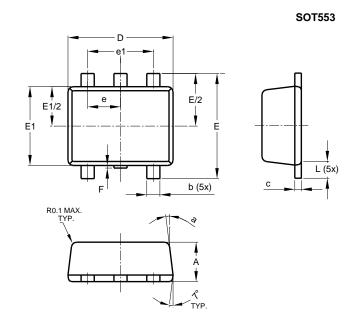


SOT353

Dimensions	Value (in mm)
С	0.650
C1	1.900
G	1.300
Х	0.420
X1	1.720
Y	0.600
Y1	2.500



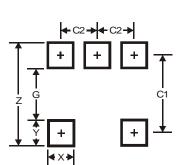
Please see http://www.diodes.com/package-outlines.html for the latest version.



SOT553				
Dim	Min	Max	Тур	
Α	0.55	0.62	0.60	
b	0.15	0.30	0.20	
С	0.10	0.18	0.15	
D	1.50	1.70	1.60	
Е	1.55	1.70	1.60	
E1	1.10	1.25	1.20	
е	0.50 BSC			
e1	1.00 BSC			
F	0.00	0.10		
L	0.10	0.30	0.20	
а	6°	8°	7°	
All D	imensio	ns in n	nm	

## **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.



SOT553

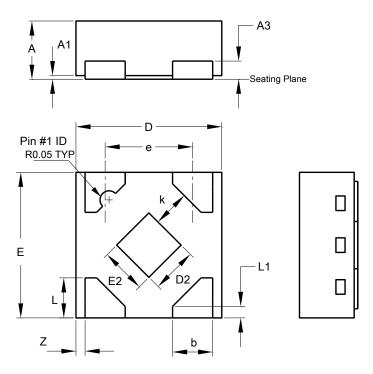
Dimensions	Value
Z	2.2
G	1.2
Х	0.375
Y	0.5
C1	1.7
C2	0.5

74LVC1G00 Document number: DS32196 Rev. 10 - 2 Downloaded from Arrow.com.



Please see http://www.diodes.com/package-outlines.html for the latest version.

### X2-DFN0808-4

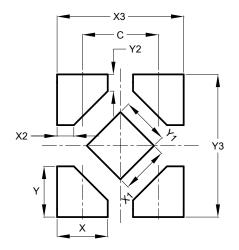


X2-DFN0808-4				
Dim	Min	Max	Тур	
Α	0.25	0.35	0.30	
A1	0	0.04	0.02	
A3	-	-	0.13	
b	0.17	0.27	0.22	
D	0.75	0.85	0.80	
D2	0.15	0.35	0.25	
E	0.75	0.85	0.80	
E2	0.15	0.35	0.25	
е	-	-	0.48	
k	0.20	-	-	
L	0.17	0.27	0.22	
L1	0.02	0.12	0.07	
z	-	-	0.05	
All Dimensions in mm				

## **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.

### X2-DFN0808-4

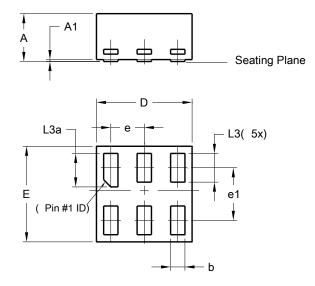


Dimensions	Value
с	0.480
Х	0.320
X1	0.300
X2	0.106
X3	0.800
Y	0.320
Y1	0.300
Y2	0.106
Y3	0.900



Please see http://www.diodes.com/package-outlines.html for the latest version.

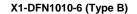
### X1-DFN1010-6 (Type B)

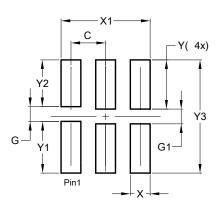


	X1-DFN1010-6 (Type B)				
Dim	Min	Max	Тур		
Α	-	0.50	0.39		
A1	-	0.04	-		
b	0.12	0.20	0.15		
D	0.95	1.050	1.00		
Е	0.95	1.050	1.00		
е	0.35 BSC				
e1		0.55 B	SC		
L3	0.27	0.30	0.30		
L3a	0.32	0.40	0.35		
All Dimensions in mm					

## **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.



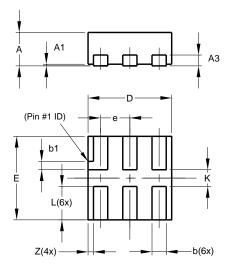


Dimensions	Value
Dimensions	(in mm)
С	0.350
G	0.150
G1	0.150
Х	0.200
X1	0.900
Y	0.500
Y1	0.525
Y2	0.475
Y3	1.150



Please see http://www.diodes.com/package-outlines.html for the latest version.

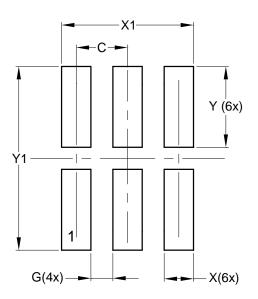




	X2-DFN1010-6			
Dim	Min	Max	Тур	
Α		0.40	0.39	
A1	0.00	0.05	0.02	
A3			0.13	
b	0.14	0.20	0.17	
b1	0.05	0.15	0.10	
D	0.95	1.05	1.00	
Е	0.95	1.05	1.00	
е	_		0.35	
L	0.35	0.45	0.40	
K	0.15			
Z			0.065	
All Dimensions in mm				

# Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



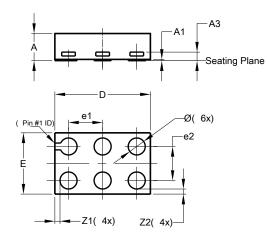
Dimensions	Value (in mm)
С	0.350
G	0.150
Х	0.200
X1	0.900
Y	0.550
Y1	1.250

### X2-DFN1010-6



Please see http://www.diodes.com/package-outlines.html for the latest version.

### X2-DFN1409-6 CHIP SCALE ALTERNATIVE

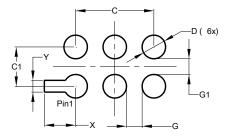


X2-DFN1409-6					
Dim	Min	Max	Тур		
Α	-	0.40	0.39		
A1	0	0.05	0.02		
A3	-	-	0.13		
Ø	0.20	0.30	0.25		
D	1.35	1.45	1.40		
ш	0.85	0.95	0.90		
e1	-	-	0.50		
e2	-	-	0.50		
Z1	-	-	0.075		
Z2	-	-	0.075		
All Dimensions in mm					

### **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.

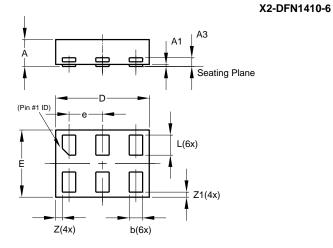
### X2-DFN1409-6 CHIP SCALE ALTERNATIVE



Dimensions	Value (in mm)	
C	1.000	
C1	0.500	
D	0.300	
G	0.200	
G1	0.200	
Х	0.400	
Ŷ	0.150	



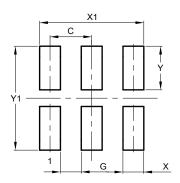
Please see http://www.diodes.com/package-outlines.html for the latest version.



X2-DFN1410-6				
Dim	Min	Max	Тур	
Α	_	0.40	0.39	
A1	0.00	0.05	0.02	
A3	_		0.13	
b	0.15	0.25	0.20	
D	1.35	1.45	1.40	
ш	0.95	1.05	1.00	
e	_		0.50	
L	0.25	0.35	0.30	
Z		_	0.10	
Z1	0.045	0.105	0.075	
All Dimensions in mm				

# Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



### X2-DFN1410-6

Dimensions	Value (in mm)	
С	0.500	
G	0.250	
Х	0.250	
X1	1.250	
Y	0.525	
Y1	1.250	



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